

## High RF Voltage Dual SPST Antenna Aperture Shunt Switch

#### **Features**

- Dual SPST designed for high-linearity antenna aperture switching and RF tuning applications
- Low R<sub>ON</sub> resistance of 1.6 ohm at each port in ON state
- Low C<sub>OFF</sub> capacitance of 240 fF at each port in OFF state
- > 67 V RF voltage OFF state handling
- Low harmonic generation
- GPIO control interface including 4 control states
- Supply voltage range: 1.65 to 3.6 V
- No RF parameter change within supply voltage range
- Small form factor 1.1 mm x 1.1 mm (MSL1, 260°C per JEDEC J-STD-020)
- Suitable for EDGE/CDMA/WCDMA/C2K/LTE/5G Applications
- RoHS and WEEE compliant package

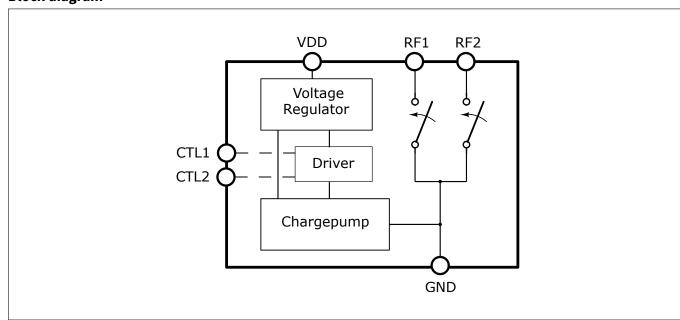
### **Application**

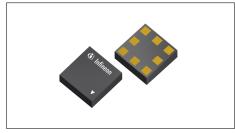
- Impedance Tuning
- Antenna Tuning
- Inductance Tuning
- Tunable Filters

#### **Product Validation**

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

### **Block diagram**





1.1 x 1.1 mm<sup>2</sup>

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### **High RF Voltage Dual SPST Antenna Aperture Shunt Switch**



#### **Features**

#### 1 Features

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RoHS (M) Halogen-Free (PB) Lead-Free (See Green







### **Description**

The BGSA20VGL8 is a versatile Dual Single Pole Single Throw (SPST) RF antenna shunt aperture switch optimized for low Coff as well as low Ron enabling applications up to 6.0 GHz. This single supply chip integrates 2 digital control pins. Unlike GaAs technology, the 0.1 dB compression point exceeds the switch maximum input power level, resulting in linear performance at all signal levels and external DC blocking capacitors at the RF ports are only required if DC voltage is applied externally. Due to its very high RF voltage ruggedness, it is suited for switching any reactive devices such as inductors and capacitors in RF matching circuits without significant losses in quality factors.

<b>Product Name</b>	Marking	Package	Ordering Information
BGSA20VGL8	V	TSLP-8-1	BGSA 20VGL8 E6327

### **High RF Voltage Dual SPST Antenna Aperture Shunt Switch**



**Maximum Ratings** 

### 2 Maximum Ratings

**Table 1: Maximum Ratings, Table I** at  $T_A = 25$  °C, unless otherwise specified

Parameter	Symbol		Value	alues Ui		Note / Test Condition
		Min.	Тур.	Max.		
Frequency Range	f	0.4	-	_	GHz	1)
Supply voltage <sup>2)</sup>	$V_{DD}$	-0.5	_	6	V	only for infrequent and short
						duration time periods
Storage temperature range	T <sub>STG</sub>	-55	-	150	°C	-
RF voltage	V <sub>RF_max</sub>	-	-	70	V	Short term peaks (1 $\mu$ s in 0.1%
						duty cycle), exceeding typical
						linearity, Ron and Coff param-
						eters, in Isolation mode, test
						condition schematic in Fig. 1
ESD robustness, CDM <sup>3)</sup>	V <sub>ESD<sub>CDM</sub></sub>	-1	_	+1	kV	
ESD robustness, HBM <sup>4)</sup>	V <sub>ESDHBM</sub>	-2	_	+2	kV	
Junction temperature	$T_j$	-	_	125	°C	-
Maximum DC-voltage on RF-Ports and RF-	$V_{RFDC}$	0	_	0	V	No DC voltages allowed on RF-
Ground						Ports
Control Voltage Levels	V <sub>CTL</sub>	-0.7	-	3.3	V	-

 $<sup>^{1)}</sup>$  Switch has a low-pass response. For higher frequencies, losses have to be considered for their impact on thermal heating. The DC voltage at RF ports  $V_{RFDC}$  has to be 0V.

Warning: Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.

<sup>&</sup>lt;sup>2)</sup> Note: Consider potential ripple voltages on top of  $V_{DD}$ . Including RF ripple,  $V_{DD}$  must not exceed the maximum ratings:  $V_{DD} = V_{DC} + V_{Ripple}$ .

<sup>&</sup>lt;sup>3)</sup> Field-Induced Charged-Device Model ANSI/ESDA/JEDEC JS-002. Simulates charging/discharging events that occur in production equipment and processes. Potential for CDM ESD events occurs whenever there is metal-to-metal contact in manufacturing.

<sup>&</sup>lt;sup>4)</sup> Human Body Model ANSI/ESDA/JEDEC JS-001 ( $R = 1.5 \text{ k}\Omega$ , C = 100 pF).



**Maximum Ratings** 

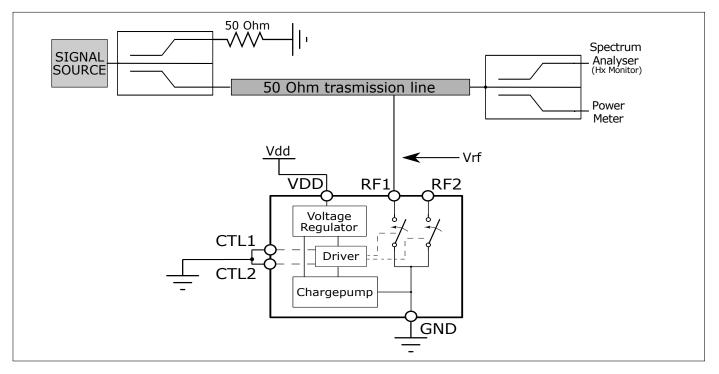


Figure 1: RF operating voltage measurement configuration - All OFF mode. RF1 stressed.

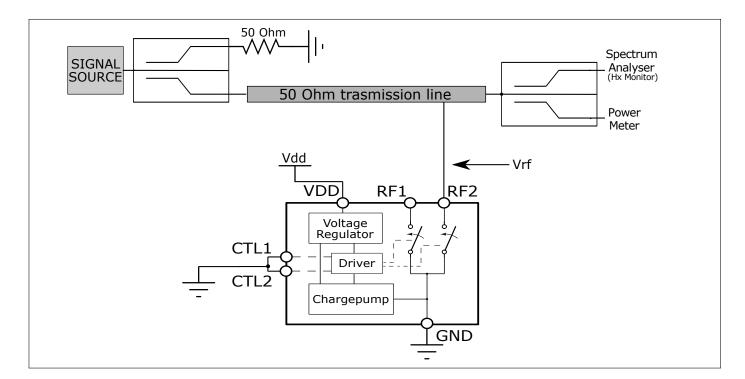


Figure 2: RF operating voltage measurement configuration - All OFF mode. RF2 stressed.

## High RF Voltage Dual SPST Antenna Aperture Shunt Switch



**DC Characteristics** 

## **3 DC Characteristics**

**Table 2: Operation Ranges** 

Parameter	Symbol		Values		Unit	Note / Test Condition
		Min.	Тур.	Max.		
Supply voltage	$V_{DD}$	1.65	2.8	3.6	V	-
Supply current	I <sub>DD</sub>	40	70	-	μΑ	-
Control voltage low	$V_{Ctl,low}$	0	_	0.45	V	-
Control voltage high	$V_{Ctl,high}$	1.2	1.8	2.85	V	$V_{Ctl,high} \ll V_{DD}$
Control current low	I <sub>Ctl,low</sub>	-1	0	1	μΑ	-
Control current high	I <sub>Ctl,high</sub>	-1	0	4	μΑ	$V_{Ctl,high} \ll V_{DD}$
						1Μ $\Omega$ Pull-Down resistor at
						Control Pins
Ambient temperature	T <sub>A</sub>	-40	25	85	°C	-
RF switching time	t <sub>ST</sub>		4.5	8	μs	$P_{IN}$ = 0 dBm, $Z_0$ = $50 \Omega$ ,
						$T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
						$V_{DD} = 1.65 - 3.6 V$
Startup time	$t_{Pup}$		8	10	μs	Referring Fig. 3

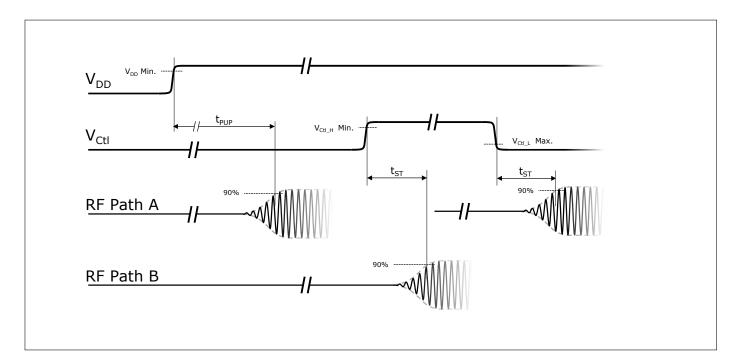


Figure 3: Switching Time Definition

### **High RF Voltage Dual SPST Antenna Aperture Shunt Switch**



**RF Small Signal Characteristics** 

# **4 RF Small Signal Characteristics**

Table 3: Parametric specifications using SPST configuration

Parameter	Symbol	Values			Unit	STATE / Notes
		Min.	Тур.	Max.		
RF1 or RF2 to Ground	R <sub>ON</sub>		1.6	1.7	Ω	
ON DC resistance						$V_{DD} = 1.65 - 3.6 V,$
RF1 or RF2 to Gnd	R <sub>OFF</sub>	250	270		kΩ	$T_A = 25 ^{\circ}\text{C}$
OFF DC resistance						
RF1 or RF2 to Ground	C <sub>OFF</sub>		240	300	fF	$V_{DD} = 1.65 - 3.6 V$ , $T_A = 25 ^{\circ}$ C,
OFF capacitance						extracted from Isolation (S21) mea-
						surement $Z_0 = 50 \Omega$

**Table 4: RF electrical parameters** 

Isolation: RF1 to RF2 or RF2 to RF1  $^{(1,2,3)}$ 

Parameter	Symbol		Values			STATE / Notes
		Min.	Тур.	Max.		
698 - 910 MHz		49	53		dB	$V_{DD} = 1.65 - 3.6 V, Z_0 = 50 \Omega,$ $T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
1710 - 1910 MHz		43	45		dB	
1911 - 2169 MHz		42	44		dB	
2170 - 2690 MHz	ISO <sub>RF1RF2</sub>	40	43		dB	
3300 - 3800 MHz		38	40		dB	- 1 <sub>A</sub> 40 C + 65 C
3801 - 4800 MHz		35	39		dB	
4801 - 6000 MHz		32	37		dB	

<sup>1)</sup> Valid for all RF power levels, no compression behavior

<sup>&</sup>lt;sup>2)</sup> SOLT-calibrated,  $P_{IN} = 0$  dBm

<sup>&</sup>lt;sup>3)</sup>On application board without any matching components

## High RF Voltage Dual SPST Antenna Aperture Shunt Switch



RF large signal parameter

# **5 RF large signal parameter**

Table 5: RF large signal specifications at  $T_A$  = 25  $^{\circ}$ C

Parameter	Symbol	Values		Unit	Note / Test Condition	
		Min.	Тур.	Max.		
Max. RF Operating Voltage	$V_{RF\_opr}$	-	-	67	V	In Isolation mode 900MHz, test con
						dition schematic in Fig. 1 or Fig. 2
						for H2/H3 < -33 dBm @ 50Ω
Harmonic Generation up to 12.7	5 GHz			·		
All RF Ports - Second Order Har-	P <sub>H2</sub>		-76	-73	dBm	25 dBm, 50Ω, $f_0$ = 663 MHz, test con
monics						dition in Fig. 1 and Fig. 2
All RF Ports - Third Order Harmon-	P <sub>H3</sub>		-86	-85	dBm	25 dBm, 50 $\Omega$ , $f_0$ = 663 MHz, test con
ics						dition in Fig. 1 and Fig. 2
All RF Ports - Second Order Har-	P <sub>H2</sub>		-58	-56	dBm	35 dBm, 50 $\Omega$ , $f_0$ = 920 MHz, test con
monics						dition in Fig. 1 and Fig. 2
All RF Ports - Third Order Harmon-	P <sub>H3</sub>		-72	-70	dBm	35 dBm, 50Ω, $f_0$ = 920 MHz, test con
ics						dition in Fig. 1 and Fig. 2
All RF Ports - Second Order Har-	P <sub>H2</sub>		-58	-55	dBm	33 dBm, 50 $\Omega$ , $f_0$ = 1910 MHz, test con
monics						dition in Fig. 1 and Fig. 2
All RF Ports - Third Order Harmon-	P <sub>H3</sub>		-70	-68	dBm	33 dBm, 50 $\Omega$ , $f_0$ = 1910 MHz, test con
ics						dition in Fig. 1 and Fig. 2
All RF Ports - Second Order Har-	P <sub>H2</sub>		-66	-64	dBm	25 dBm, $50Ω$ , $f_0$ = 2690 MHz, test con
monics						dition in Fig. 1 and Fig. 2
All RF Ports - Third Order Harmon-	P <sub>H3</sub>		-79	-77	dBm	25 dBm, $50Ω$ , $f_0$ = 2690 MHz, test con
ics						dition in Fig. 1 and Fig. 2
All RF Ports - Second Order Har-	P <sub>H2</sub>		-65	-63	dBm	25 dBm, $50Ω$ , $f_0$ = 3500 MHz, test con
monics						dition in Fig. 1 and Fig. 2
All RF Ports - Third Order Harmon-	P <sub>H3</sub>		-80	-78	dBm	25 dBm, $50Ω$ , $f_0$ = 3500 MHz, test con
ics						dition in Fig. 1 and Fig. 2
All RF Ports - Second Order Har-	P <sub>H2</sub>		-66	-64	dBm	25 dBm, $50\Omega$ , $f_0 = 5000$ MHz, test con
monics						dition in Fig. 1 and Fig. 2
All RF Ports - Third Order Harmon-	P <sub>H3</sub>		-81	-80	dBm	25 dBm, $50\Omega$ , $f_0 = 5000$ MHz, test con
ics						dition in Fig. 1 and Fig. 2
All RF Ports	$P_{Hx}$	_	_	-80	dBm	25 dBm, 50Ω
Intermodulation Distortion IMD	1					
IIP2, low	IIP2,l	123	125	131	dBm	IIP2 conditions table 8
IIP2, high	IIP2,h	127	130	135	dBm	iii 2 conditions table 0
Intermodulation Distortion IMD	_					
IIP3	IIP3	77	78	79	dBm	IIP3 conditions table 9

## High RF Voltage Dual SPST Antenna Aperture Shunt Switch



### RF large signal parameter

### Table 6: IIP2 conditions table

Band	In-Band Frequency	Blocker Frequency 1	Blocker Power 1	Blocker Frequency 2	Blocker Power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 1 Low	2140	1950	20	190	-15
Band 1 High	2140	1950	20	4090	-15
Band 5 Low	881.5	836.5	20	45	-15
Band 5 High	881.5	836.5	20	1718	-15

### Table 7: IIP3 conditions table

Band	In-Band Frequency	Blocker Frequency 1	Blocker Power 1	Blocker Frequency 2	Blocker Power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 1	2140	1950	20	1760	-15
Band 5	881.5	836.5	20	791.5	-15

### **High RF Voltage Dual SPST Antenna Aperture Shunt Switch**



**Application Information** 

## 6 Logic Table

**Table 8: Logic Table** 

CTL 1	CTL 2	Mode			
0	0	RF1 and RF2 isolated from ground			
0	1	RF2 connected to ground			
1	0	RF1 connected to ground			
1	1	RF1 and RF2 connected to ground			

## 7 Application Information

### **Pin Configuration and Function**

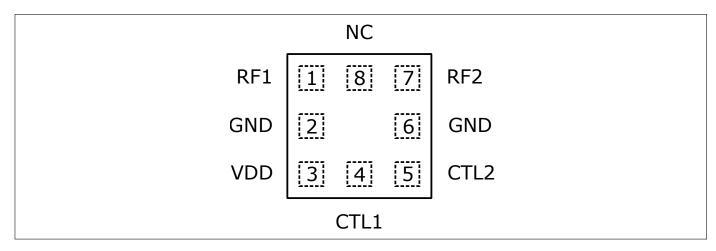


Figure 4: BGSA20VGL8 Pin Configuration (top view)

**Table 9: Pin Definition and Function** 

Pin No.	Name	Function
1	RF1	RF port
2	GND	Ground
3	VDD	DC Supply Voltage
4	CTL1	Control Pin 1
5	CTL2	Control Pin 2
6	GND	Ground
7	RF2	RF port
8	NC	Not Connected

#### Table 10: ESD robustness, System Level Test (SLT)

			•	•		
Parameter	Symbol	Values		Unit	Note / Test Condition	
		Min.	Тур.	Max.	]	
ESD SLT 1)	V <sub>ESD<sub>SIT</sub></sub>	-8	_	+8	kV	RF1, RF2 vs system GND, with 27 nH shunt inductor

<sup>&</sup>lt;sup>1)</sup> IEC 61000-4-2 ( $R = 330 \Omega$ , C = 150 pF), contact discharge.



**Package Information** 

## **8 Package Information**

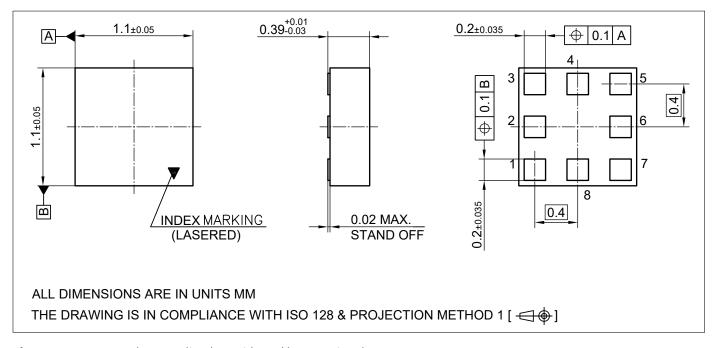


Figure 5: TSLP-8-1 Package Outline (top, side and bottom views)

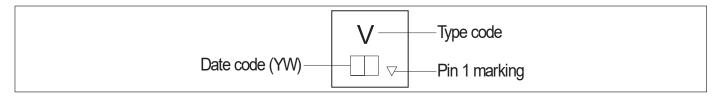


Figure 6: Marking Specification (top view): Date code digits Y and W defined in Table 11/12

## High RF Voltage Dual SPST Antenna Aperture Shunt Switch



Package Information

Table 11: Year date code marking - digit "Y"

				9	
Year	"Y"	Year	"Y"	Year	"Y"
2010	0	2020	0	2030	0
2011	1	2021	1	2031	1
2012	2	2022	2	2032	2
2013	3	2023	3	2033	3
2014	4	2024	4	2034	4
2015	5	2025	5	2035	5
2016	6	2026	6	2036	6
2017	7	2027	7	2037	7
2018	8	2028	8	2038	8
2019	9	2029	9	2039	9

Table 12: Week date code marking - digit "W"

Week	"W"	Week	"W"	Week	"W"	Week	"W"	Week	"W"
1	Α	12	N	23	4	34	h	45	v
2	В	13	Р	24	5	35	j	46	x
3	С	14	Q	25	6	36	k	47	у
4	D	15	R	26	7	37	l	48	z
5	E	16	S	27	a	38	n	49	8
6	F	17	Т	28	b	39	р	50	9
7	G	18	U	29	С	40	q	51	2
8	Н	19	V	30	d	41	r	52	3
9	J	20	W	31	e	42	s	53	М
10	К	21	Υ	32	f	43	t		
11	L	22	Z	33	g	44	u		

### **High RF Voltage Dual SPST Antenna Aperture Shunt Switch**



### **Package Information**

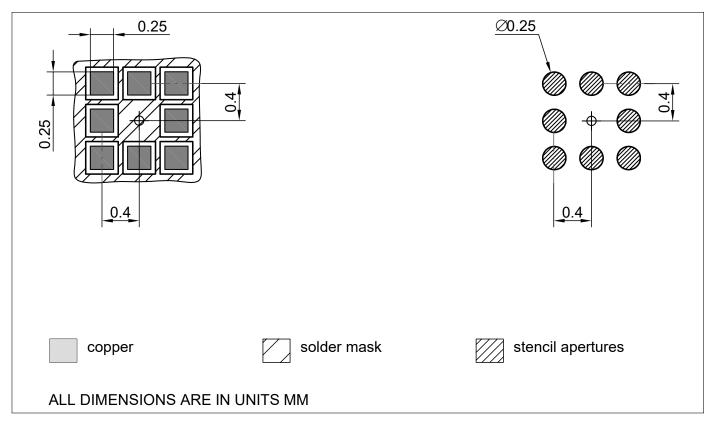


Figure 7: Footprint Recommendation

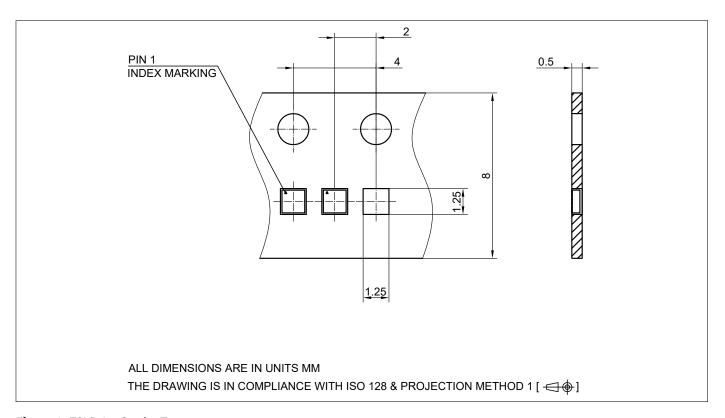


Figure 8: TSLP-8-1 Carrier Tape





Revision History				
Creation of document Revision 2.1, 2021-06-23				
Page or Item	Subjects (major changes since previous revision)			
-	Release of the final datasheet			

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